TR-52D-433

Transceiver Module

Data Sheet





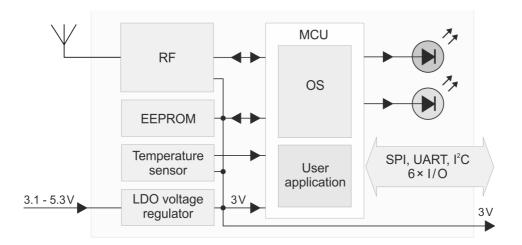
Description

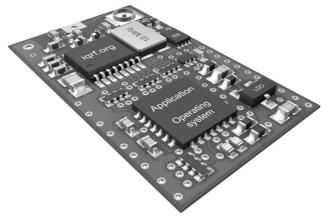
TR-52D-433 is a family of IQRF transceiver modules operating in the 433 MHz license free ISM (Industry, Scientific and Medical) frequency band. Its highly integrated ready-to-use design requires no external components. Microcontroller with built-in operating system, excellent development support, integrated LDO regulator, serial EEPROM and optional temperature sensor dramatically reduce time of application development. Ultra low power consumption predetermines these modules for use in battery powered applications.

Key features

- · Complete solution with operating system, easy to use
- FSK modulation
- RF band 433 MHz, multiple channel
- · Selectable RF bit rate
- MCU with extended resources, user interrupt capability
- Extra low power consumption, power management modes
- SPI interface supported by OS on background
- Serial EEPROM
- PWM output
- Programmable HW timer
- +3 V LDO regulator output, battery monitoring
- 2 LEDs
- 8 pins, 6 I/Os
- A/D converter (2 channels), analog comparator
- Options: on-board antenna, U.FL connector, temperature sensor
- SIM card format

Block diagram





Applications

- Telemetry
- · Building automation
- · Wireless control & regulation
- Access control
- Remote data acquisition
- Communication links
- · RF connectivity in many other areas



Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

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Electrical specifications

Typical values unless otherwise stated

Parameters specified in this datasheet are typical values. They are at power supply $V_{OUT} = 3 \text{ V}$ only. V_{OUT} voltage different from 3 V can impact on RF range and other parameters.

Supply voltage (V_{CC}) 3.1 V to 5.3 V

LDO output (V_{OUT}) +3 V ± 60 mV (V_{CC} > 3.1 V), 100 mA max.

Operating temperature ¹ -40 °C to +85 °C

Supply current

Sleep mode 1.9 µA (if all peripherals including MRF49XA disabled ³)

Run mode 1 mA (MRF49XA disabled)

Additional LED supply current cca 2 mA (if one or two LEDs on). Rough value for brief guidance only.

RX mode STD mode: 12 mA

LP mode ⁴: 330 μA XLP mode ⁴: 25 μA

TX mode 13 mA – 23 mA (according to RF output power)

RF band 433 MHz

Channels See IQRF OS User's guide, Appendix 2, Channel maps

RF data modulation FSK (frequency-shift keying)

RF data transmission bit rate 1.2 kb/s ⁵, 19.2 kb/s, 57.6 kb/s ⁵, 86.2 kb/s ⁵

RFIC RF sensitivity See MRF49XA datasheet

RFIC RF output power Programmable in 8 levels (0-7), -2.5 dBm/level, see MRF49XA datasheet

Input voltage on C1, C2, C5 to C8 pins $0 \text{ V to } V_{\text{OUT}}$

A/D converter 10 bit, 2 inputs, see PIC16LF1938 datasheet

Temperature sensor TMP112 (for TR modules with the "T" postfix only, e.g. TR-52DT-433)

Size (L x W x H) 25.0 mm x 14.9 mm x 2.0 mm

Note 1: RF range may change with lower temperature. Frost, condensation or humidity over 85% may disable module functionality. Module suitability should be tested in final application before volume use.

Note 2: RF range strongly depends on module orientation and surroundings.

Note 3: Additional current is consumed when a peripheral (e.g. watchdog, Brown-out detection etc.) is enabled.

Note 4: Depends on interferences.

Note 5: RF bit rates different from 19.2 kb/s are preliminary, for experimental purpose only.

Users have to ensure observing local provisions and restrictions relating to the use of short range devices by software, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

Caution: Electrostatic sensitive device. Observe appropriate precautions for handling



Absolute maximum ratings

Stresses above listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation at these or any other conditions beyond those specified is not supported.

Supply voltage (V_{cc})

5.5 V

Voltage on C1, C2, C5 to C8 pins vs. GND

 $-0.3 \text{ V to (V}_{\text{OUT}} + 0.3 \text{ V)}$

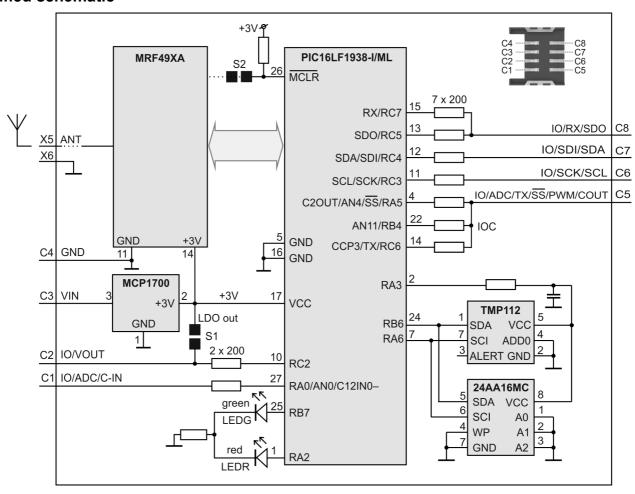
Storage temperature

-40 °C to +85 °C

Ambient temperature under bias

-40 °C to +85 °C

Simplified schematic



Basic components

IC	Туре	Manufacturer	Note
MCU	PIC16LF1938–I/ML	Microchip	
RF IC	MRF49XA	Microchip	
LDO voltage regulator	MCP1700	Microchip	
Temperature sensor	TMP112	Texas Instruments	TR-52DxTx-433 only
EEPROM	24AA16/MC	Microchip	

For more information refer to datasheets of ICs used.



Pin	Name	Description		
C1	IO/ADC/C-II RA0 AN0 C12IN0	N General I/O pin Analog A/D input Comparator –input		
C2	IO/VOUT RC2 VOUT	General I/O pin (S1 disconnected) On-board +3 V LDO output (S1 connected)	ed)	
С3	VIN	Power supply voltage		
C4	GND	Ground		
C5	RA5 -SS AN4 C2OUT RC6	I-SS / PWM / COUT General I/O pin, SPI Slave select Analog A/D input Comparator output General I/O pin	S2 S2 RESET TRC C5 S1 S1 LDO OUT	
	TX CCP3	UART TX PWM output	P3 C2 C6	
	RB4	General I/O pin, programmable pull-up and interrupt/wake-up on change (IOC), RFPGM termination Analog A/D input	P4 C3 P1 C7 X5	
C6	IO/SCK/SCI RC3 SCK SCL	General I/O pin SPI clock input I ² C clock	P5 C4 C8 TR-52D X6 V 1.00	
C7	IO/SDI/SDA RC4 SDI SDA	General I/O pin SPI data I ² C data	Connect to enable LDO output Bottom view	
C8	IO/RX/SDO RC5 SDO	6 General I/O pin SPI data out		
	RC7 RX	General I/O pin UART RX		
X5	ANT	Antenna input		
X6	GND	Ground		
P1-P5		For factory programming only		
S1		LDO output enable. Connect to enable (default disabled).		
S2		Leave disconnected.		

Note 6: This pin is used as output during initial ~250 ms boot-up to recognize programming mode.

Figure 1: Relative RF range vs. level for the setTXpower(level) function. Refer to IQRF OS Reference guide.

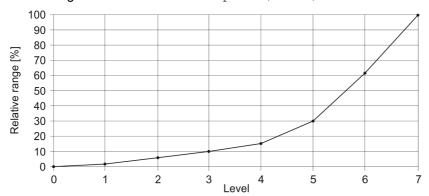
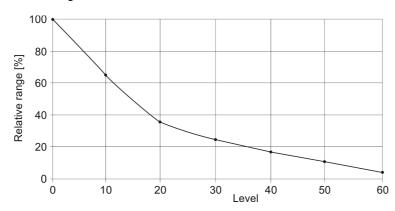
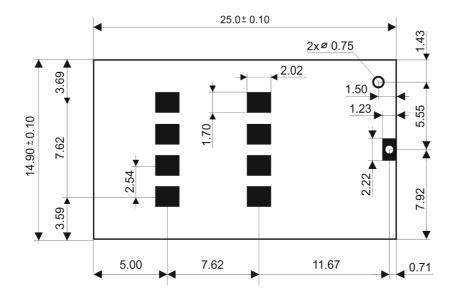


Figure 2: Relative RF range vs. level for the checkRF (level) function. Refer to IQRF OS Reference guide.



Dimensions



Top view, Units: mm

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Application

Assembly

TR-52Dxxx-433 modules should be mounted in SIM connector. They are not intended for SMT reflow soldering. Recommended SIM connector: KON-SIM-01.

Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

Software

See Application examples on www.iqrf.org website.

Programming

There are the following possibilities to upload an application program in TR-52Dx modules:

- Wired upload with TR-52Dx plugged via the SIM connector in the CK-USB-04 or CK-USB-04A programmer.
- For TR-52Dx modules populated in an application:
 - Wired upload using the CK-USB-04A programmer. See the CK-USB-04A User's guide.
 - Wired upload using the CK-USB-04 programmer and the KON-TR-01P adapter. See the KON-TR-01P User's guide.
 - RFPGM RF programming[™] (wireless upload). See the IQRF OS User's guide, Appendix RF programming.

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Product information

Ordering codes

T R - 5 2 D \underline{A} \underline{P} - 433

□ RF band [MHz]□ Peripheral options: nil - No other peripheral

T - Temperature sensor

Antenna options: nil - Soldering padhole (no antenna, no U.FL connector)

c - U.FL connector (mini coax)

Туре	Antenna connection	Temperature sensor	RF shielding
TR-52D-433	Soldering hole	_	_
TR-52DC-433	U.FL connector	_	_

Туре	Antenna connection	Temperature sensor	RF shielding
TR-52DT-433	Soldering hole	Yes	_
TR-52DCT-433	U.FL connector	Yes	_







TR-52D-433

TR-52DC-433

TR-52DT-433

Document history

• 150414 TR-52DxF removed from available types.

• 141103 Chapters *Pin description* and *Programming* slightly updated.

Information regarding directives RoHS and WEEE updated and extended.

140120 Datasheet file renamed from DS TR-52D-433 131114 to Datasheet TR-52D-433 140120

• 131114 Certification updated for the latest directives.

130906 First release.



Sales and Service

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Quality management

ISO 9001: 2009 certified

Complies with ETSI directives EN 301489-1 V1.9.2:2011, EN 301489-3 V1.6.1:2013, EN 300220-1 V2.4.1:2012, EN 300220-2 V2.4.1:2012 and VO-R/10/04.2012-7.



Complies with directives 2011/65/EU (RoHS) and 2012/19/EU (WEEE).

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